

DATA SHEET

74F242

Quad transceiver, inverting (3-State)

74F243

Quad transceiver (3-State)

Product specification

1990 Aug 31

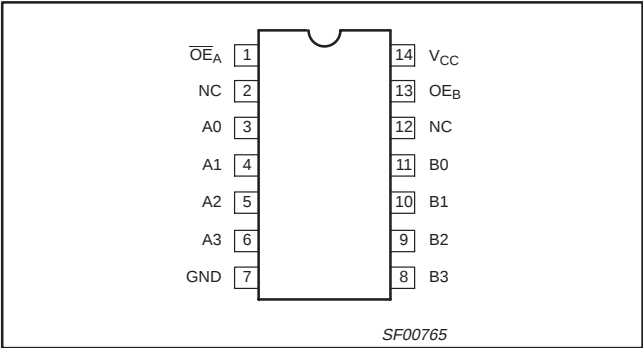
IC15 Data Handbook

Transceivers

74F242/74F243

74F242 Quad Transceiver, Inverting (3-State)
74F243 Quad Transceiver (3-State)

PIN CONFIGURATION



TYPE	TYPICAL PROPAGATION DELAY	TYPICAL SUPPLY CURRENT (TOTAL)
74F242	4.3ns	31.2mA
74F243	4.0ns	66mA

ORDERING INFORMATION

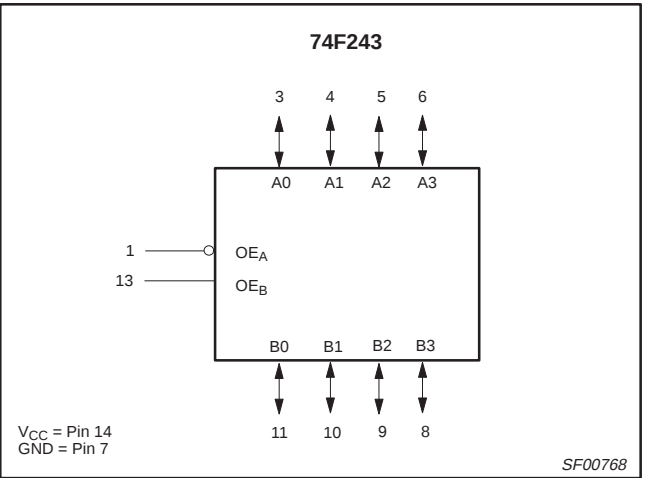
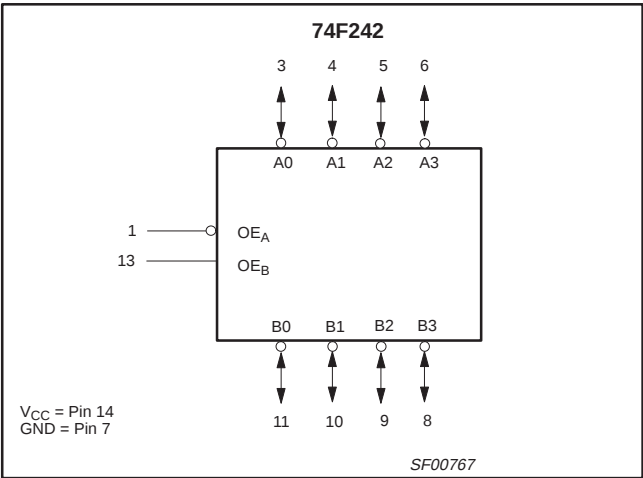
DESCRIPTION	COMMERCIAL RANGE $V_{CC} = 5V \pm 10\%$, $T_{amb} = 0^{\circ}C$ to $+70^{\circ}C$	PKG DWG #
14-pin plastic DIP	N74F242N, N74F243N	SOT27-1
14-pin plastic SO	N74F242D, N74F243D	SOT108-1

INPUT AND OUTPUT LOADING AND FAN-OUT TABLE

PINS	DESCRIPTION	74F (U.L.) HIGH/LOW	LOAD VALUE HIGH/LOW
An, Bn	Data inputs (74F242)	3.5/1.67	70 μ A/1.0mA
An, Bn	Data inputs (74F243)	3.5/2.67	70 μ A/1.6mA
$\overline{OE}_A$	Output enable input (active Low)	1.0/1.67	20 μ A/1.0mA
OE_B	Output enable input	1.0/1.67	20 μ A/1.0mA
An, Bn	Data outputs	750/106.7	15mA/64mA

NOTE: One (1.0) FAST unit load is defined as: 20 μ A in the High state and 0.6mA in the Low state.

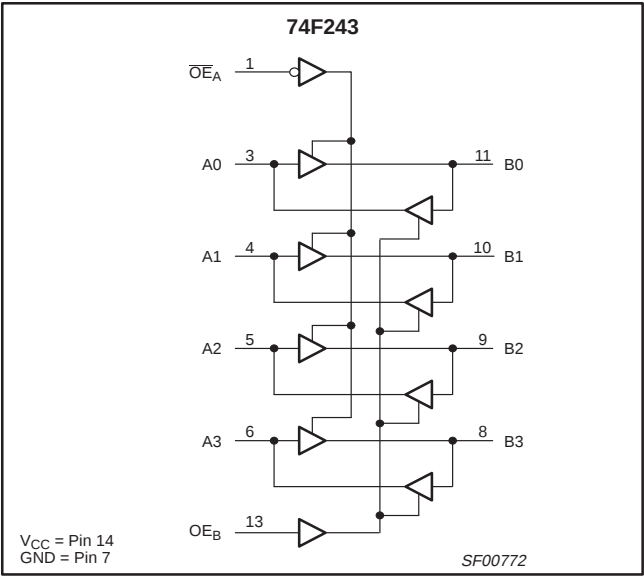
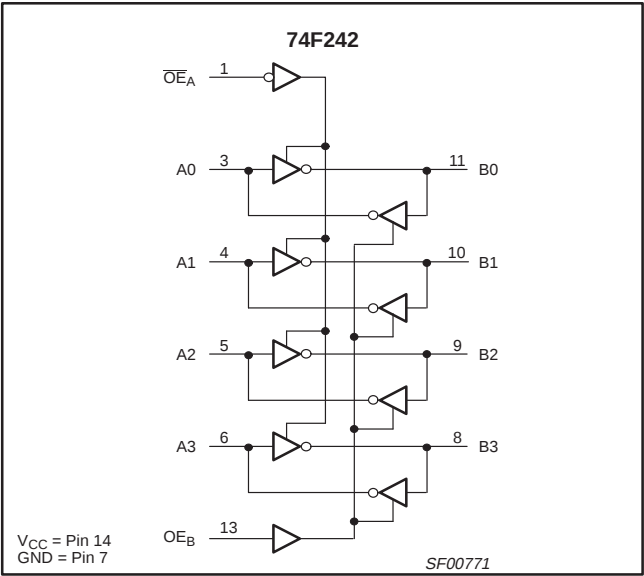
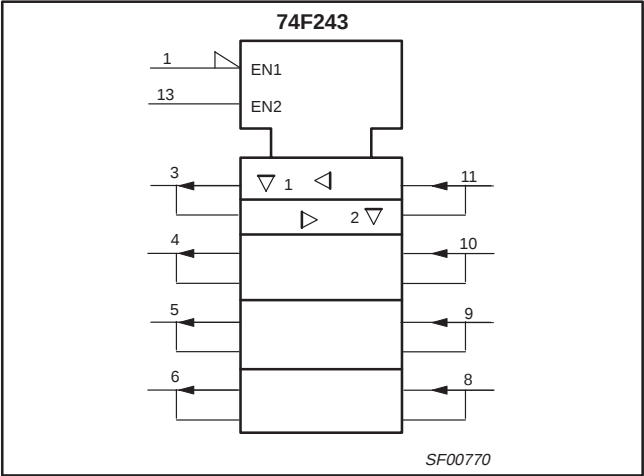
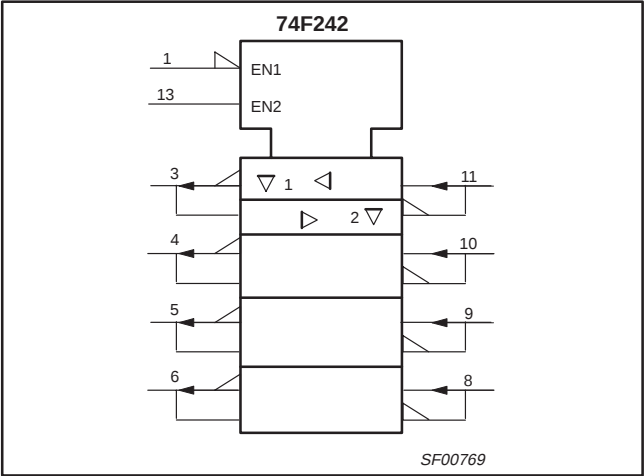
LOGIC SYMBOLS



Transceivers

74F242/74F243

LOGIC SYMBOLS (IEEE/IEC)



LOGIC DIAGRAMS
FUNCTION TABLE, 74F242

INPUTS		OUTPUTS	
$\overline{OE}_A$	OE_B	A _n	B _n
L	L	INPUT	$B=\overline{A}$
H	L	Z	Z
L	H	a	a
H	H	$A=\overline{B}$	INPUT

H = High voltage level
L = Low voltage level
Z = High impedance "off" state
a = This condition is not allowed due to excessive currents

FUNCTION TABLE, 74F243

INPUTS		OUTPUTS	
$\overline{OE}_A$	OE_B	A _n	B _n
L	L	INPUT	$B=A$
H	L	Z	Z
L	H	a	a
H	H	$A=B$	INPUT

Transceivers

74F242/74F243

ABSOLUTE MAXIMUM RATINGS

(Operation beyond the limits set forth in this table may impair the useful life of the device.

Unless otherwise noted these limits are over the operating free-air temperature range.)

SYMBOL	PARAMETER	RATING	UNIT
V _{CC}	Supply voltage	−0.5 to +7.0	V
V _{IN}	Input voltage	−0.5 to +7.0	V
I _{IN}	Input current	−30 to +5	mA
V _{OUT}	Voltage applied to output in High output state	−0.5 to V _{CC}	V
I _{OUT}	Current applied to output in Low output state	128	mA
T _{amb}	Operating free-air temperature range	0 to +70	°C
T _{stg}	Storage temperature	−65 to +150	°C

RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	LIMITS			UNIT
		MIN	NOM	MAX	
V _{CC}	Supply voltage	4.5	5.0	5.5	V
V _{IH}	High-level input voltage	2.0			V
V _{IL}	Low-level input voltage			0.8	V
I _{IK}	Input clamp current			−18	mA
I _{OH}	High-level output current			−15	mA
I _{OL}	Low-level output current			64	mA
T _{amb}	Operating free-air temperature range	0		70	°C

Transceivers

74F242/74F243

DC ELECTRICAL CHARACTERISTICS

(Over recommended operating free-air temperature range unless otherwise noted.)

SYMBOL	PARAMETER		TEST CONDITIONS ¹			LIMITS			UNIT
						MIN	TYP ²	MAX	
V _{OH}	High-level output voltage		V _{CC} = MIN, V _{IL} = MAX, V _{IH} = MIN	I _{OH} = −3mA	±10%V _{CC}	2.4			V
					±5%V _{CC}	2.7	3.3		
			V _{CC} = MIN, V _{IL} = MAX, V _{IH} = MIN	I _{OL} = −15mA	±10%V _{CC}	2.0	3.2		V
					±5%V _{CC}	2.0	3.1		
V _{OL}	Low-level output voltage		V _{CC} = MIN, V _{IL} = MAX, V _{IH} = MIN	I _{OH} =MAX	±10%V _{CC}			0.55	V
					±5%V _{CC}		0.42	0.55	
V _{IK}	Input clamp voltage		V _{CC} = MIN, I _I = I _{IK}				−0.73	−1.2	V
I _I	Input current at maximum input voltage	A0–A3, B0–B3	V _{CC} = MAX, V _I = 5.5V					1	mA
		$\overline{\text{OE}}_{\text{A}}$, OE _B	V _{CC} = MAX, V _I = 7.0V					100	μA
I _{IH}	High-level input current	OE _A , OE _B only	V _{CC} = MAX, V _I = 2.7V					20	μA
I _{IL}	Low-level input current		V _{CC} = MAX, V _I = 0.5V					−1	mA
I _{IH} +I _{OZH}	Off-state output current High-level voltage applied		V _{CC} = MAX, V _O = 2.7V					70	μA
I _{IL} +I _{OZL}	Off-state output current Low-level voltage applied	74F242	V _{CC} = MAX, V _O = 0.5V					−1.0	mA
		74F243						−1.6	
I _{OS}	Short-circuit output current ³		V _{CC} = MAX			−100		−225	mA
I _{CC}	Supply current (total)	74F242	I _{CCH}	V _{CC} = MAX			22	35	mA
			I _{CCL}				40	55	mA
			I _{CCZ}				32	45	mA
		74F243	I _{CCH}	V _{CC} = MAX			64	80	mA
			I _{CCL}				64	90	mA
			I _{CCZ}				71	90	mA

NOTES:

- For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type.
- All typical values are at $V_{CC} = 5\text{V}$, $T_{\text{amb}} = 25^\circ\text{C}$.
- Not more than one output should be shorted at a time. For testing I_{OS} , the use of high-speed test apparatus and/or sample-and-hold techniques are preferable in order to minimize internal heating and more accurately reflect operational values. Otherwise, prolonged shorting of a High output may raise the chip temperature well above normal and thereby cause invalid readings in other parameter tests. In any sequence of parameter tests, I_{OS} tests should be performed last.

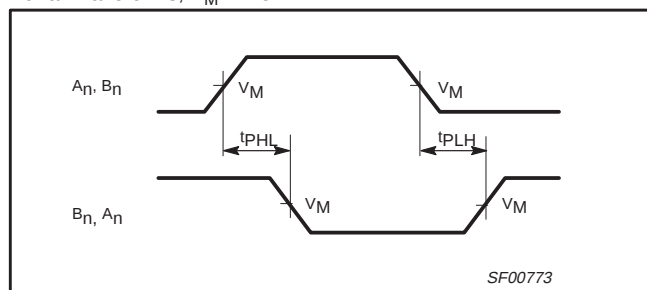
Transceivers

74F242/74F243

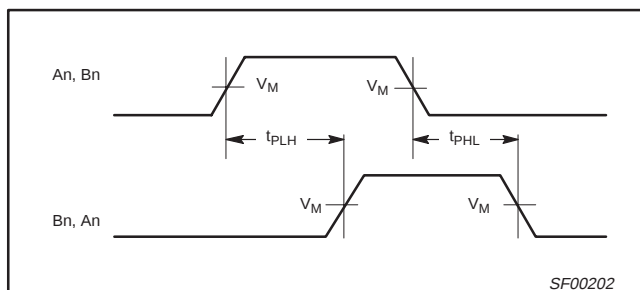
AC ELECTRICAL CHARACTERISTICS

SYMBOL	PARAMETER		TEST CONDITION	LIMITS					UNIT
				V _{CC} = +5V T _{amb} = +25°C C _L = 50pF, R _L = 500Ω			V _{CC} = +5V ± 10% T _{amb} = 0°C to +70°C C _L = 50pF, R _L = 500Ω		
				MIN	TYP	MAX	MIN	MAX	
t _{PLH} t _{PHL}	Propagation delay An, Bn to Bn, An	74F242	Waveform NO TAG	2.5 2.0	3.5 3.0	6.0 4.5	2.5 2.0	7.0 4.5	ns
t _{PZH} t _{PZL}	Output Enable time to High or Low level		Waveform 3 Waveform 4	3.0 3.5	4.0 6.5	7.0 9.0	3.0 3.5	8.0 10.5	ns
t _{PHZ} t _{PLZ}	Output Disable time from High or Low level		Waveform 3 Waveform 4	3.5 3.5	5.5 6.0	8.5 9.5	3.5 3.5	9.0 11.0	ns
t _{PLH} t _{PHL}	Propagation delay An, Bn to Bn, An	74F243	Waveform 2	2.5 2.5	4.0 4.0	5.2 5.2	2.0 2.0	6.2 6.5	ns
t _{PZH} t _{PZL}	Output Enable time to High or Low level		Waveform 3 Waveform 4	2.0 2.0	4.5 5.0	5.7 7.5	2.0 2.0	6.7 8.5	ns
t _{PHZ} t _{PLZ}	Output Disable time from High or Low level		Waveform 3 Waveform 4	2.0 2.0	4.0 4.5	6.0 6.0	2.0 2.0	7.0 7.0	ns

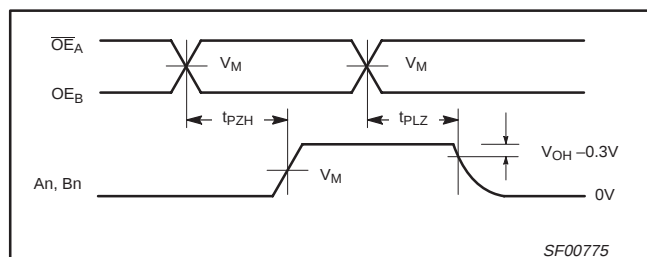
AC WAVEFORMS

For all waveforms, $V_M = 1.5V$.

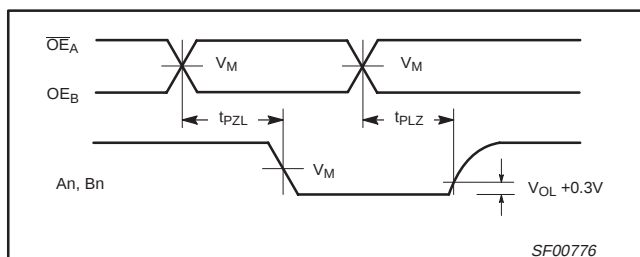
Waveform 1. For Inverting Outputs



Waveform 2. For Non-Inverting Outputs



Waveform 3. 3-State Output Enable Time to High Level and Output Disable Time from High Level

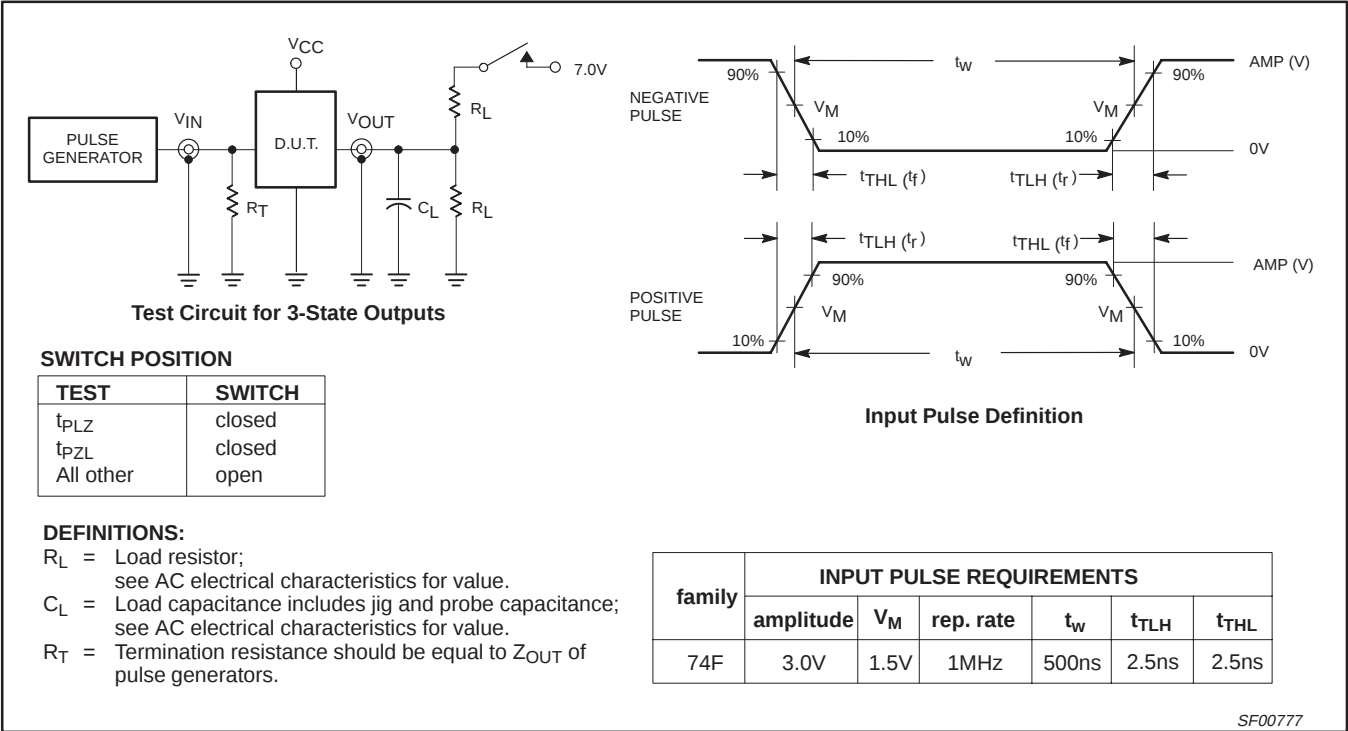


Waveform 4. 3-State Output Enable Time to Low Level and Output Disable Time from Low Level

Transceivers

74F242/74F243

TEST CIRCUIT AND WAVEFORMS

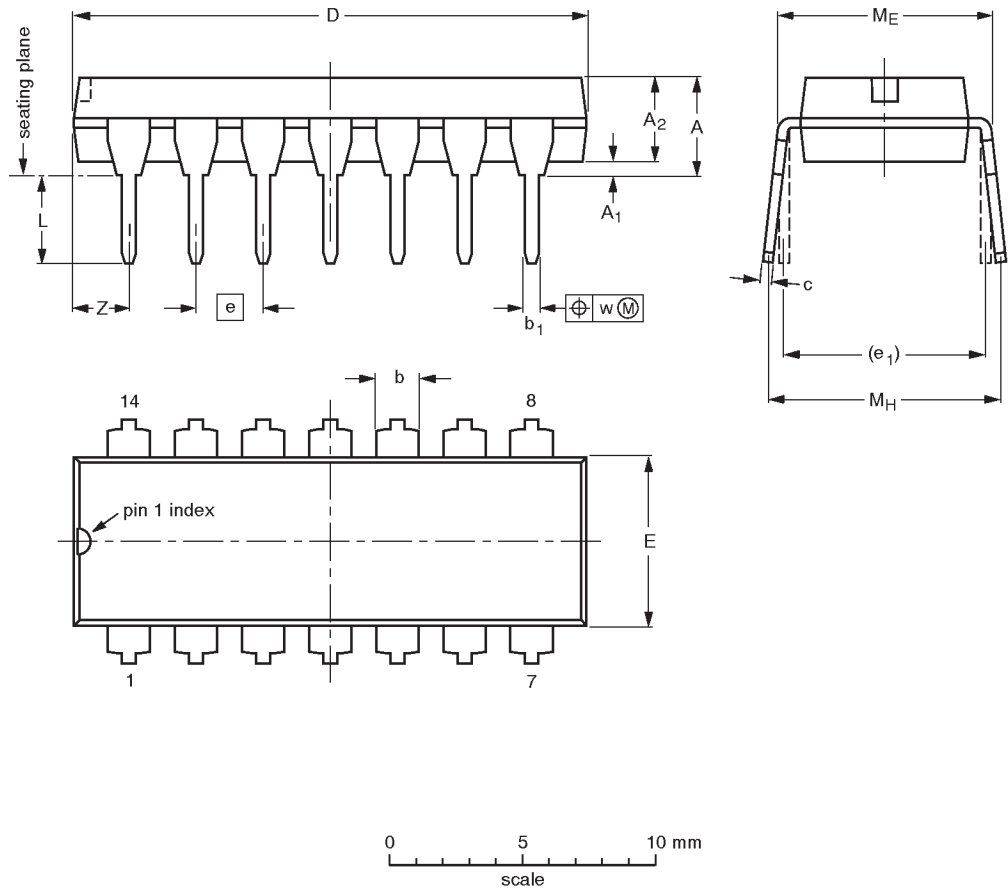


Transceivers

74F242, 74F243

DIP14: plastic dual in-line package; 14 leads (300 mil)

SOT27-1



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A ₁ min.	A ₂ max.	b	b ₁	c	D ⁽¹⁾	E ⁽¹⁾	e	e ₁	L	M _E	M _H	w	Z ⁽¹⁾ max.
mm	4.2	0.51	3.2	1.73 1.13	0.53 0.38	0.36 0.23	19.50 18.55	6.48 6.20	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	2.2
inches	0.17	0.020	0.13	0.068 0.044	0.021 0.015	0.014 0.009	0.77 0.73	0.26 0.24	0.10	0.30	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.087

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

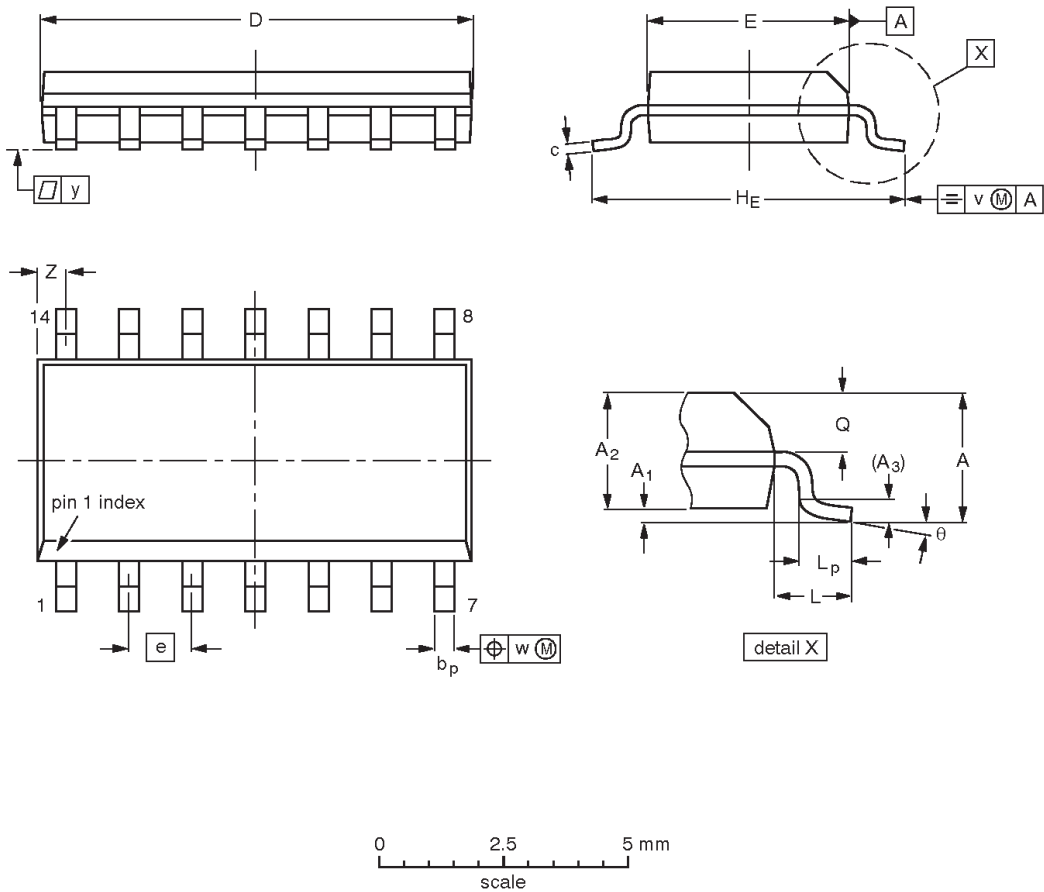
OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT27-1	050G04	MO-001AA				92-11-17 95-03-11

Transceivers

74F242, 74F243

SO14: plastic small outline package; 14 leads; body width 3.9 mm

SOT108-1



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A ₁	A ₂	A ₃	b _p	c	D ⁽¹⁾	E ⁽¹⁾	e	H _E	L	L _p	Q	v	w	y	Z ⁽¹⁾	θ
mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	8.75 8.55	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8° 0°
inches	0.069	0.010 0.004	0.057 0.049	0.01	0.019 0.014	0.0100 0.0075	0.35 0.34	0.16 0.15	0.050	0.244 0.228	0.041	0.039 0.016	0.028 0.024	0.01	0.01	0.004	0.028 0.012	

Note

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT108-1	076E06S	MS-012AB				95-01-23 97-05-22

Transceivers

74F242, 74F243

Data sheet status

Data sheet status	Product status	Definition [1]
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.
Preliminary specification	Qualification	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.
Product specification	Production	This data sheet contains final specifications. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.

[1] Please consult the most recently issued datasheet before initiating or completing a design.

Definitions

Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

Application information — Applications that are described herein for any of these products are for illustrative purposes only. Philips Semiconductors make no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Disclaimers

Life support — These products are not designed for use in life support appliances, devices or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips Semiconductors customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips Semiconductors for any damages resulting from such application.

Right to make changes — Philips Semiconductors reserves the right to make changes, without notice, in the products, including circuits, standard cells, and/or software, described or contained herein in order to improve design and/or performance. Philips Semiconductors assumes no responsibility or liability for the use of any of these products, conveys no license or title under any patent, copyright, or mask work right to these products, and makes no representations or warranties that these products are free from patent, copyright, or mask work right infringement, unless otherwise specified.

Philips Semiconductors
811 East Arques Avenue
P.O. Box 3409
Sunnyvale, California 94088-3409
Telephone 800-234-7381

© Copyright Philips Electronics North America Corporation 1998
All rights reserved. Printed in U.S.A.

print code

Date of release: 10-98

Document order number:

9397-750-05102

Let's make things better.